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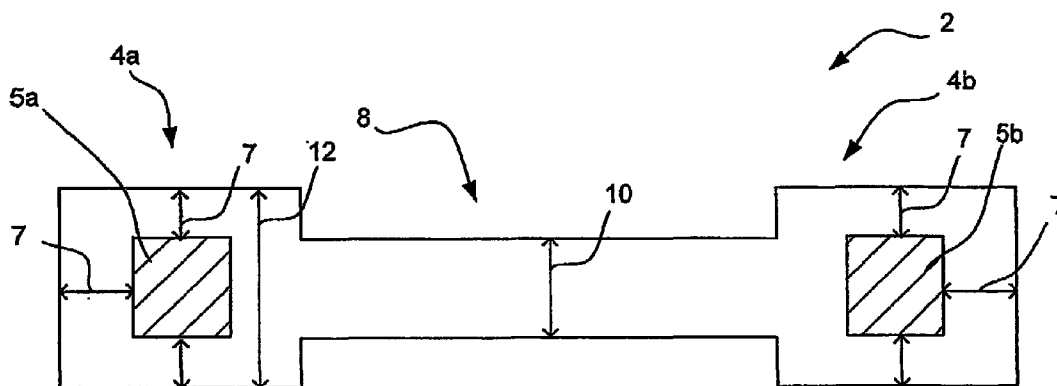
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- (71) Applicant: **MICRON TECHNOLOGY, INC.** [US/US];
8000 South Federal Way, P.O. Box 6, Boise, ID 83707-0006 (US).
- (72) Inventors: **LIU, Harry**; 18915 39th Avenue, Plymouth, MN 55446 (US). **LARSON, William**; 11719 Eden Prairie, Minneapolis, MN 55347 (US). **BERG, Lonny**; 19402 Lander Street NW, Elk River, MN 55330 (US). **ZHU, Theodore**; 6257 Quantico Lane, Maple Grove, MN 55311 (US). **LI, Shaoping**; 3641 Lancaster Lane N. #205, Plymouth, MN 55441 (US). **KATTI, Romney, R.**; 8636 Terraceview Lane N., Maple Grove, MN 55447 (US). **LI, Yong**; 3301 Hwy 169 N. #311, Plymouth, MN 55441 (US). **ARROTT, Anthony**; 5026 Reno Road, Washington, DC 20008 (US).
- (74) Agent: **HUNT, Dale, C.**; KNOBBE, MARTENS, OLSON & BEAR, LLP, 2040 Main Street, 14th Floor, Irvine, CA 92614 (US).
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(54) Title: MAGNETO-RESISTIVE BIT STRUCTURE AND METHOD OF MANUFACTURING THEREFOR



(57) Abstract: Embodiments of the present invention provide a magnetic bit structure that can be produced using conventional contact and/or via processing steps. This is preferably accomplished by providing a magnetic bit structure that has bit ends that are sufficiently large to accommodate a minimum size contact or via hole. As such, the contact or via holes may remain inside of the bit edges, thereby protecting the edges of the bit from later process steps that would otherwise cause oxidation or damage the bit structure.



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